

DAFTAR GAMBAR

Gambar I. 2 Solusi Integrasi pengawsan SHMS	2
Gambar II. 2 Mikrokontroler Nucleo-WB55 (STMicroelectronics, 2019).....	7
Gambar II. 3 Nucleo Board Mechanical Drawing (STMicroelectronics, 2019).....	8
Gambar II. 4 USB dongle mechanical drawing (STMicroelectronics, 2019).....	9
Gambar II. 5 Skema Node LoRa.....	9
Gambar II. 6 Modulasi Lora GPS HAT	10
Gambar II. 7 Sensor SW-420	11
Gambar II. 8 Arduino UNO	12
Gambar II. 9 Samsung ICR18650 2600mAh.....	16
Gambar II. 10 Solar Panel 5V	17
Gambar II. 11 Proses Perancangan Desain	19
Gambar II. 12 <i>Workflow finite element analysis</i>	21
Gambar II. 13 Contoh barang menggunakan material <i>Polycarbonate</i>	24
Gambar II. 14 Polyamide 6	25
Gambar II. 15 Autodesk Inventore Professional. Diambil dari (Autodesk,2024). 26	
Gambar III. 1 Sistematika Penyelesaian Masalah.....	33
Gambar IV. 1 Tampak atas <i>casing SHMS</i>	39
Gambar IV. 2 Tampak samping <i>casing SHMS</i>	39
Gambar IV. 3 Sistematika proses perancangan <i>casing SHMS</i>	43
Gambar IV. 4 Drawing view Protective Upper Base	44
Gambar IV. 5 Drawing view Upper Base Circuit	45
Gambar IV. 6 Drawing view Base Station	45
Gambar IV. 7 Protective Upper Base	46
Gambar IV. 8 Tampak atas Upper Base Circuit	47
Gambar IV. 9 Tampak samping atas Base Station	48
Gambar IV. 10 Load Properties.....	49
Gambar IV. 11 Detail Material Properties pada Autodesk Nastran.....	50
Gambar IV. 12 Constraints Casing SHMS.....	51
Gambar IV. 13 Pembebanan Casing SHMS.....	51
Gambar IV. 14 Mesh Settings	52

Gambar IV. 15 <i>Meshing</i> Casing SHMS	52
Gambar IV. 16 Persiapan <i>Casing</i> sebelum simulasi.....	53
Gambar IV. 17 Hasil simulasi Displacement	55
Gambar IV. 18 Rancangan CAM Protective Upper Base	57
Gambar IV. 19 Hasil <i>Prototype</i> Protective Upper Base	62
Gambar IV. 20 Proses Permesinan <i>Prototype</i> Protective Upper Base	62
Gambar IV. 21 Hasil <i>Prototype</i> Upper Base Circuit	63
Gambar IV. 22 Proses Permesinan CNC part Upper Base Circuit.....	63